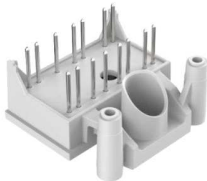
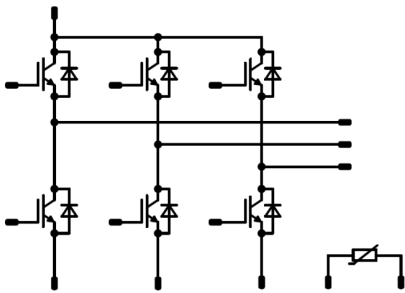
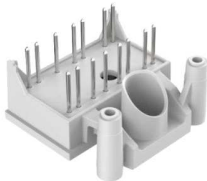
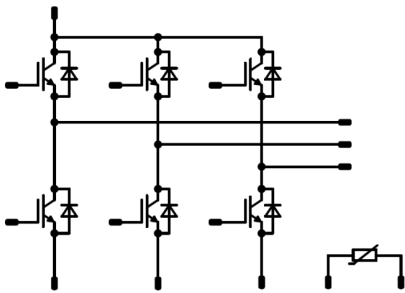
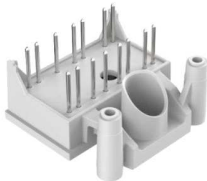
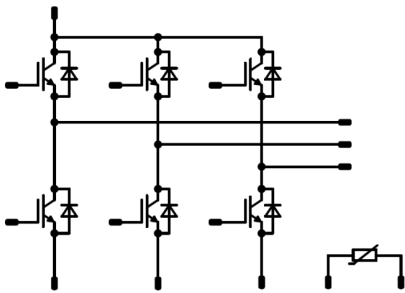




Vincotech

flowPACK 0B	1200 V / 15 A										
<table border="1" style="width:100%; border-collapse: collapse;"> <tr> <th style="background-color: #cccccc;">Features</th> </tr> <tr> <td> <ul style="list-style-type: none"> IGBT4 (1200 V) technology Open emitter topology New ultra-compact housing Single-screw heat sink mounting </td> </tr> </table> <table border="1" style="width:100%; border-collapse: collapse;"> <tr> <th style="background-color: #cccccc;">Target applications</th> </tr> <tr> <td> <ul style="list-style-type: none"> Dedicated design for motor drive </td> </tr> </table> <table border="1" style="width:100%; border-collapse: collapse;"> <tr> <th style="background-color: #cccccc;">Types</th> </tr> <tr> <td> <ul style="list-style-type: none"> 10-0B126PA015SC-M999F09 </td> </tr> </table>	Features	<ul style="list-style-type: none"> IGBT4 (1200 V) technology Open emitter topology New ultra-compact housing Single-screw heat sink mounting 	Target applications	<ul style="list-style-type: none"> Dedicated design for motor drive 	Types	<ul style="list-style-type: none"> 10-0B126PA015SC-M999F09 	<table border="1" style="width:100%; border-collapse: collapse;"> <tr> <th style="background-color: #cccccc;">flow0 17 mm housing</th> </tr> <tr> <td style="text-align: center;">  </td> </tr> </table> <table border="1" style="width:100%; border-collapse: collapse;"> <tr> <th style="background-color: #cccccc;">Schematic</th> </tr> <tr> <td style="text-align: center;">  </td> </tr> </table>	flow0 17 mm housing		Schematic	
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<ul style="list-style-type: none"> 10-0B126PA015SC-M999F09 											
flow0 17 mm housing											
											
Schematic											
											

Inverter switch maximum ratings

T_j=25°C, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Collector-emitter break down voltage	V_{CES}		1200	V
DC collector current	I_C	$T_j = T_{jmax}$ $T_h = 80^\circ C$	20	A
Pulsed collector current	I_{Cpulse}	t_p limited by T_{jmax}	45	A
Power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_h = 80^\circ C$	56	W
Gate-emitter peak voltage	V_{GE}		±20	V
Short circuit ratings	t_{SC}	$T_j \leq 150^\circ C$	10	µs
	V_{CC}	$V_{GE} = 15V$	800	V
Maximum Junction Temperature	T_{jmax}		175	°C

Inverter diode maximum ratings

Parameter	Symbol	Conditions	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
DC forward current	I_F	$T_j = T_{jmax}$ $T_h = 80^\circ C$	21	A
Repetitive peak forward current	I_{FRM}		30	A
Power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_h = 80^\circ C$	43	W
Maximum Junction Temperature	T_{jmax}		175	°C



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Inverter switch characteristic values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max		
Static										
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}$			0,0005	25 125	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		15	25 150	1,6	1,89 2,28	2,1	V
Collector-emitter cut-off	I_{CES}		0	1200		25 125			2	μA
Gate-emitter leakage current	I_{GES}		20	0		25 125			120	nA
Integrated Gate resistor	R_{gint}							none		Ω
Input capacitance	C_{ies}							900		pF
Output capacitance	C_{oss}	f=1 MHz	0	25		25		80		
Reverse transfer capacitance	C_{riss}							55		
Gate charge	Q_{Gate}		15	960	15	25		93		nC

Thermal

Thermal resistance chip to heatsink	R_{thJH}	Thermal grease thickness≤50um $\lambda = 1$ W/mK						1,7		K/W
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Inverter dynamic values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] or V_{GS} [V]	V_r [V] or V_{CE} [V]	I_C [A] or I_f [A] or I_b [A]	T_j [°C]	Min	Typ	Max		
IGBT Switching										
Turn-on delay time	$t_{d(on)}$					25 150		86 84		ns
Rise time	t_r	$R_{goff}=32\Omega$ $R_{gon}=32\Omega$				25 150		18 24		
Turn-off delay time	$t_{d(off)}$		±15	600	15	25 150		201 264		
Fall time	t_f					25 150		81 130		
Turn-on energy loss per pulse	E_{on}	$Q_{rrFWD}=1,5\mu C$				25 150		0,952 1,402		mWs
Turn-off energy loss per pulse	E_{off}					25 150		0,829 1,371		

FWD Switching

Peak recovery current	I_{RRM}	922				25 150		15 16		A
Reverse recovery time	t_{rr}	922				25 150		289 447		ns
Reverse recovery charge	Q_{rr}	922	±15	600	15	25 150		1,542 2,681		μC
Reverse recovered energy	E_{rec}	922				25 150		0,626 1,076		mWs
Peak rate of fall of recovery current	$di(rec)_{max}/dt$	922				25 150		92 59		A/μs



Inverter diode characteristic values

Parameter	Symbol	Conditions					Value			Unit
		di_f/dt [A/us]	V_r [V]	I_f [A]	T_j	Min	Typ	Max		
Static										
Forward voltage	V_F			15	25°C 150°C		1,80 1,77	2,05		V
Reverse leakage current	I_{rm}		1200		25°C 150°C			3,5 -		μA
Thermal										
Thermal resistance chip to heatsink	R_{thJH}	Thermal grease thickness≤50um $\lambda = 1$ W/mK					2,2			K/W

Thermistor

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V]	V_{CE} [V]	I_c [A]	T_j [°C]	Min	Typ	Max		
Rated resistance	R				25		21,5			kΩ
Deviation of R100	$\Delta R/R$	R100=1486 Ω			100	-4,5		+4,5		%
Power dissipation	P				25		210			mW
Power dissipation constant					25		3,5			mW/K
B-value	B(25/50)				25		3884			K
B-value	B(25/100)				25		3964			K
Vincotech NTC Reference								F		

Module Properties

Parameter	Symbol	Conditions	Value	Unit
Thermal Properties				
Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{op}		-40...+(T_{jmax} - 25)	°C
Insulation Properties				
Insulation voltage	V_{isol}	DC Test Voltage* $t_p = 2s$	6000	V
		$t_p = 1 min$	2500	V
Creepage distance			min 12,7	mm
Clearance			min 12,7	mm
Comparative tracking index	CTI		>200	

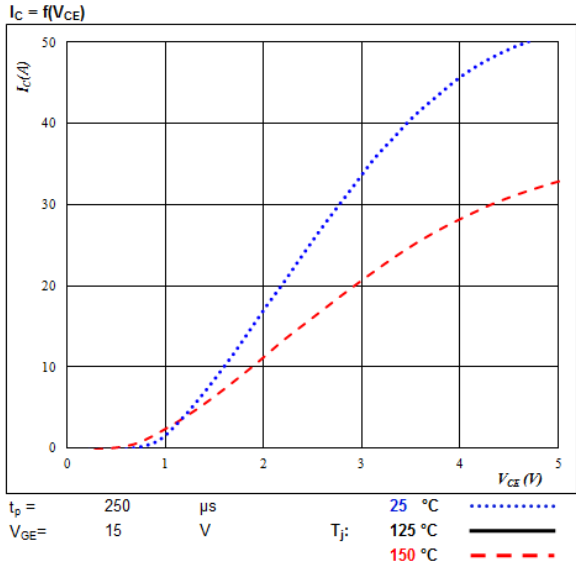
*100 % tested in production



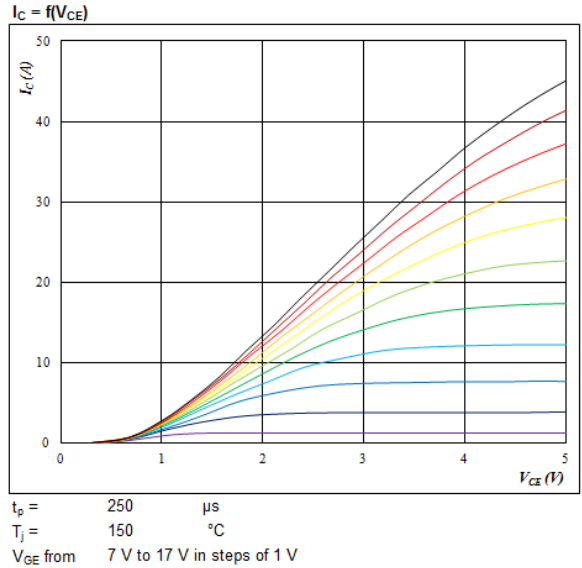
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Inverter switch characteristics

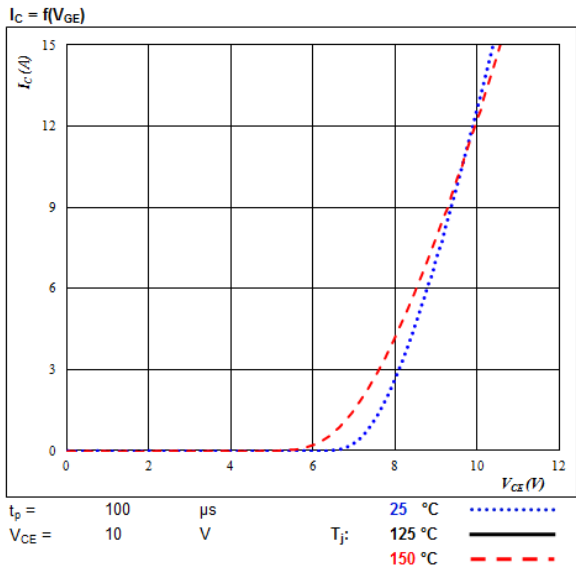
Typical output characteristics IGBT



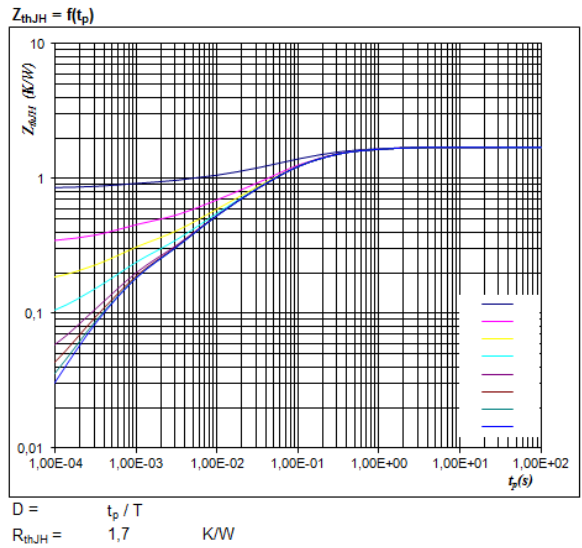
Typical output characteristics IGBT



Typical transfer characteristics IGBT



Transient thermal impedance as a function of pulse width IGBT



IGBT thermal model values

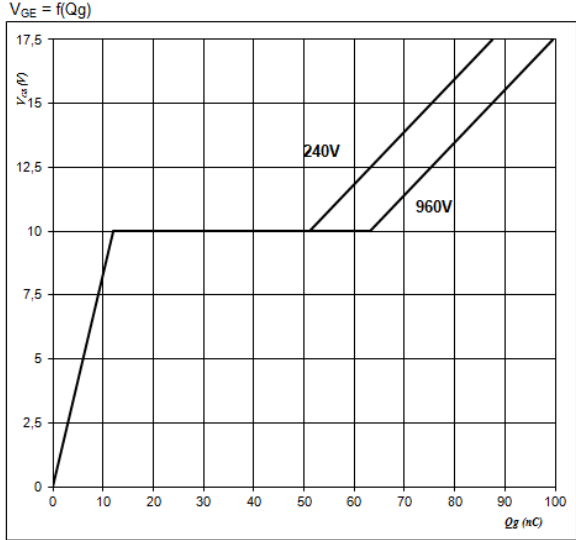
R (K/W)	Tau (s)
1,32E-01	1,36E+00
5,21E-01	2,19E-01
5,88E-01	5,73E-02
3,04E-01	8,98E-03
1,49E-01	7,03E-04



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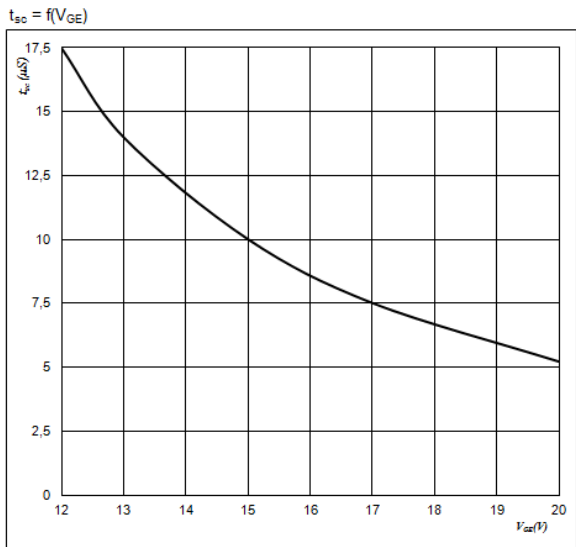
Inverter switch characteristics

Gate voltage vs Gate charge IGBT



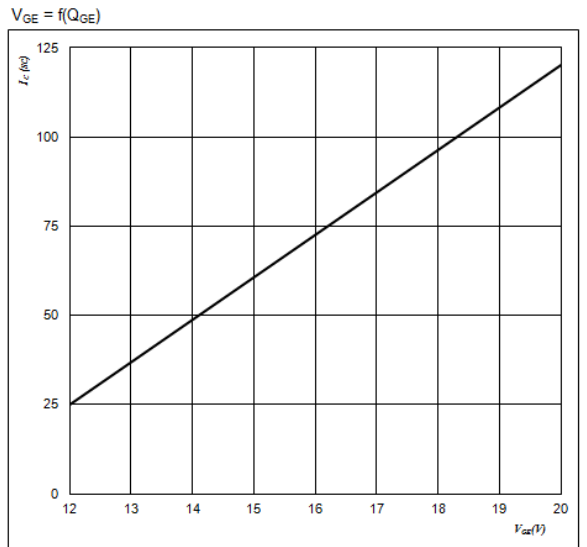
At
 $I_C = 15$ A

Short circuit withstand time as a function of V_{GE} IGBT



At
 $V_{CE} = 1200$ V
 $T_j \leq 175$ °C

Typical short circuit collector current as a function of V_{GE} IGBT



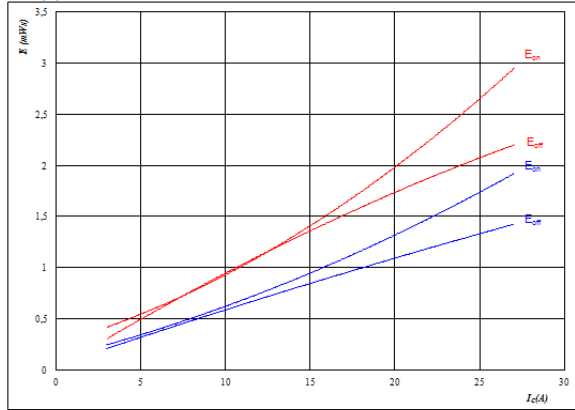
At
 $V_{CE} \leq 1200$ V
 $T_j = 175$ °C



Inverter switching characteristics

Figure 1. IGBT

Typical switching energy losses as a function of collector current
 $E = f(I_C)$

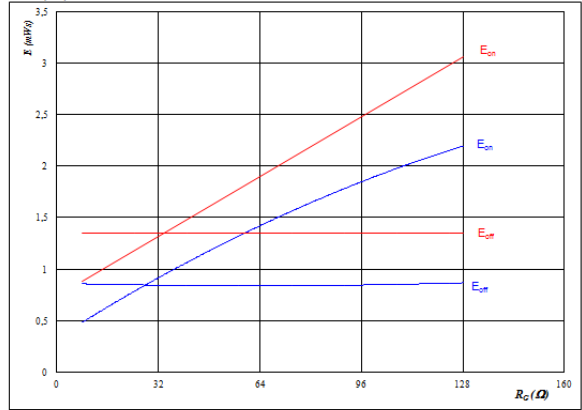


With an inductive load at

$T_J = 25/125/150$ °C $R_{gon} = 32$ Ω
 $V_{CE} = 600$ V $R_{goff} = 32$ Ω
 $V_{GE} = \pm 15$ V

Figure 2. IGBT

Typical switching energy losses as a function of gate resistor
 $E = f(R_G)$

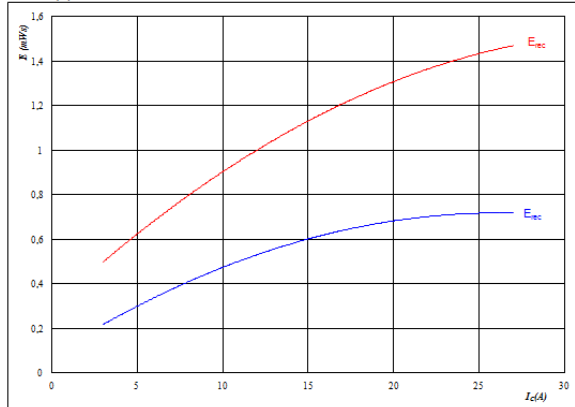


With an inductive load at

$T_J = 25/125/150$ °C $V_{GE} = \pm 15$ V
 $V_{CE} = 600$ V $I_C = 15$ A

Figure 3. FWD

Typical reverse recovery energy loss as a function of collector (drain) current
 $E_{rec} = f(I_C)$

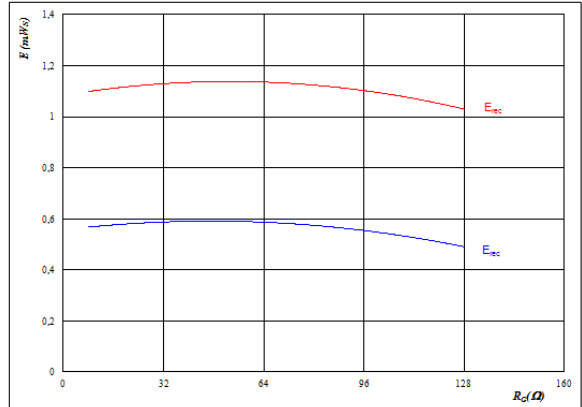


With an inductive load at

$T_J = 25/125/150$ °C $R_{gon} = 32$ Ω
 $V_{CE} = 600$ V $R_{goff} = 32$ Ω
 $V_{GE} = \pm 15$ V

Figure 4. FWD

Typical reverse recovery energy loss as a function of gate resistor
 $E_{rec} = f(R_G)$

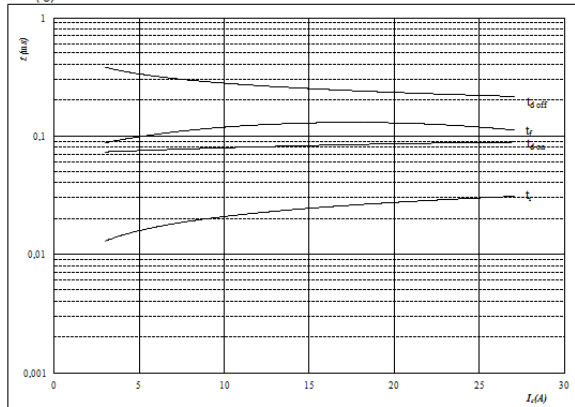


With an inductive load at

$T_J = 25/125/150$ °C $V_{GE} = \pm 15$ V
 $V_{CE} = 600$ V $I_C = 15$ A

Figure 5. IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$

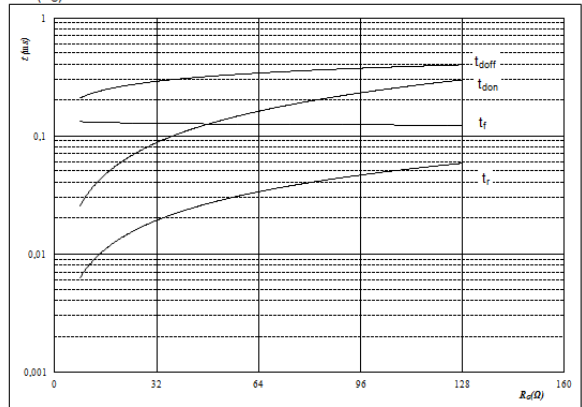


With an inductive load at

$T_J = 150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 32$ Ω
 $R_{goff} = 32$ Ω

Figure 6. IGBT

Typical switching times as a function of gate resistor
 $t = f(R_G)$



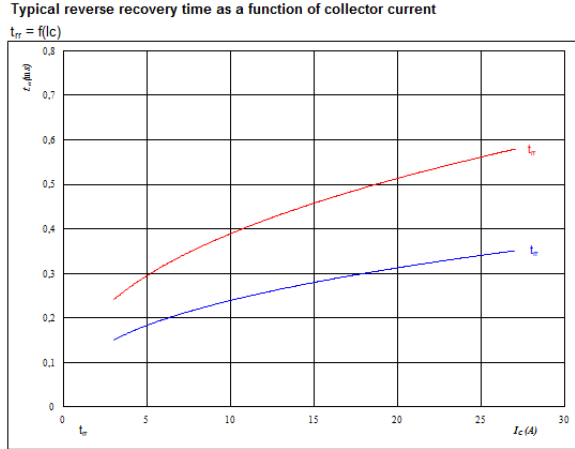
With an inductive load at

$T_J = 150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $I_C = 15$ A



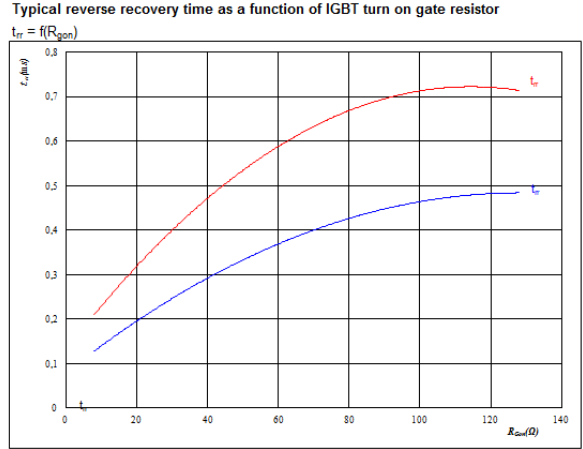
Inverter switching characteristics

Figure 7. Typical reverse recovery time as a function of collector current FWD



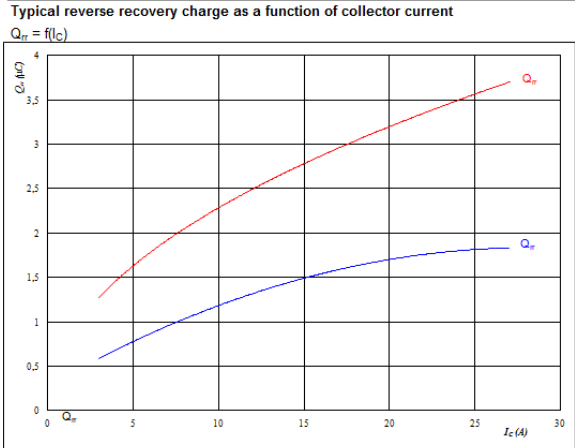
At
 $T_j = 25/125/150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 32$ Ω

Figure 8. Typical reverse recovery time as a function of IGBT turn on gate resistor FWD



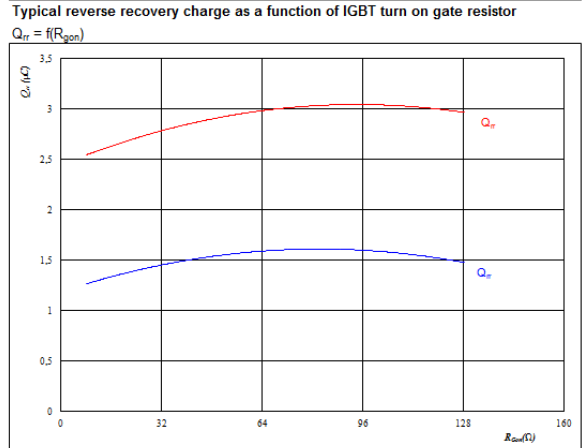
At
 $T_j = 25/125/150$ °C
 $V_R = 600$ V
 $I_F = 15$ A
 $V_{GE} = \pm 15$ V

Figure 9. Typical reverse recovery charge as a function of collector current FWD



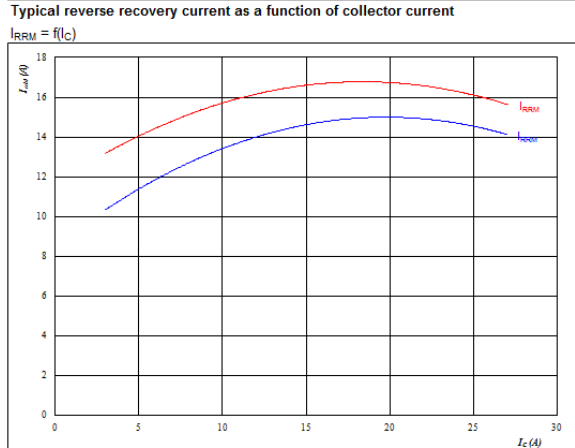
At
 $T_j = 25/125/150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 32$ Ω

Figure 10. Typical reverse recovery charge as a function of IGBT turn on gate resistor FWD



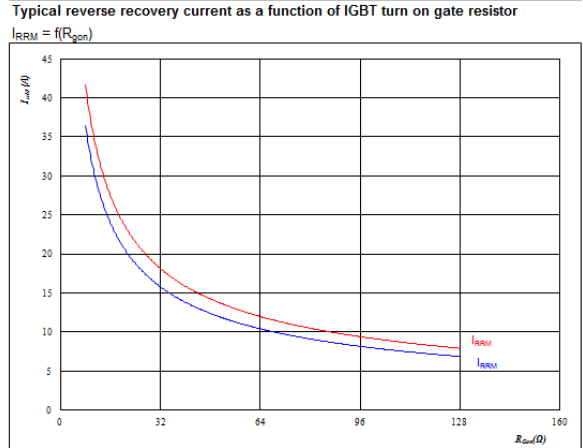
At
 $T_j = 25/125/150$ °C
 $V_R = 600$ V
 $I_F = 15$ A
 $V_{CE} = \pm 15$ V

Figure 11. Typical reverse recovery current as a function of collector current FWD



At
 $T_j = 25/125/150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 32$ Ω

Figure 12. Typical reverse recovery current as a function of IGBT turn on gate resistor FWD



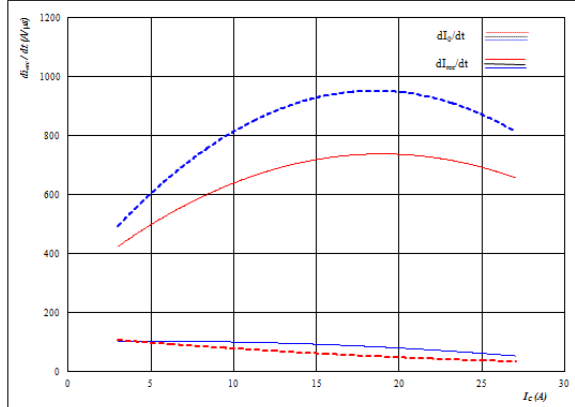
At
 $T_j = 25/125/150$ °C
 $V_R = 600$ V
 $I_F = 15$ A
 $V_{GE} = \pm 15$ V



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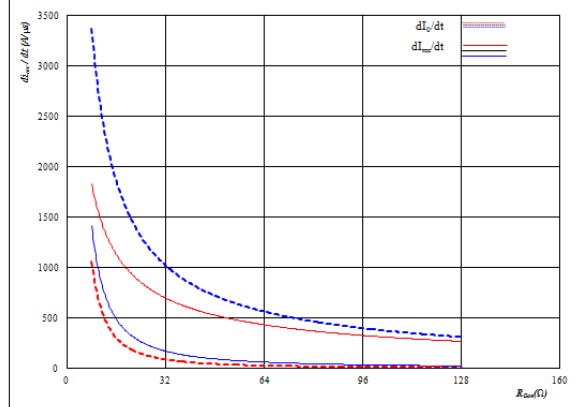
Inverter switching characteristics

Figure 13. FWD
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_c/dt, di_{reg}/dt = f(I_c)$



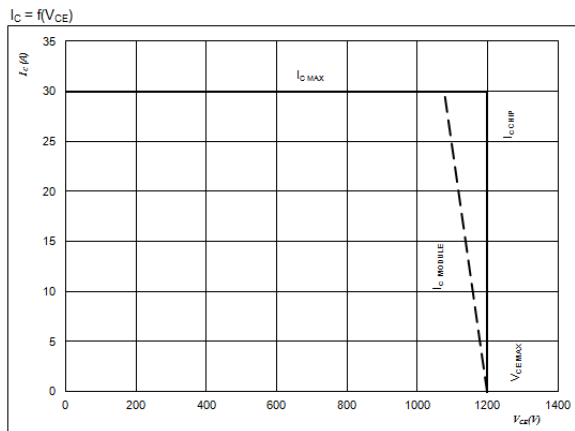
At
 $T_j = 25/125/150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 32$ Ω

Figure 14. FWD
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor



At
 $T_j = 25/125/150$ °C
 $V_R = 600$ V
 $I_F = 15$ A
 $V_{GE} = \pm 15$ V

Figure 15. IGBT
Reverse bias safe operating area



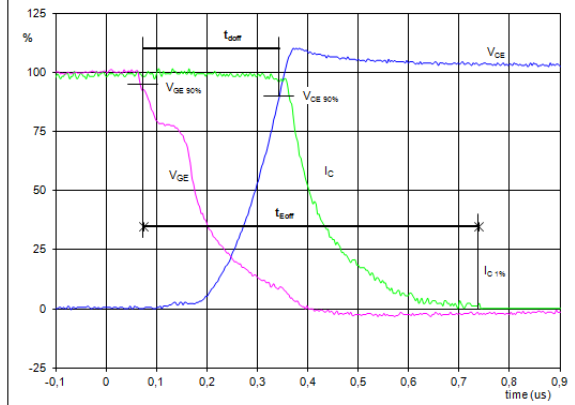
At
 $T_j = 175$ °C
 $R_{gon} = 32$ Ω
 $R_{goff} = 32$ Ω



Switching Definitions

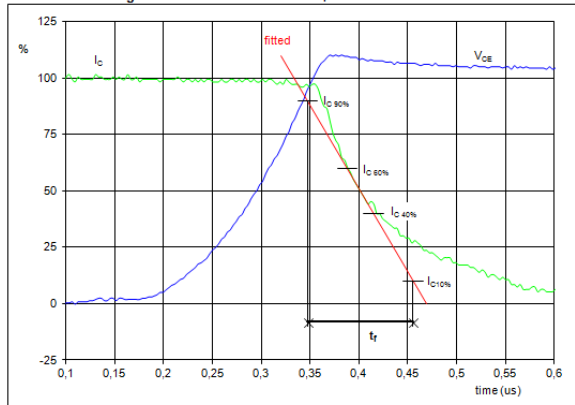
General conditions	
T_j	= 150 °C
$R_{g\text{on}}$	= 32 Ω
$R_{g\text{off}}$	= 32 Ω

Figure 1. IGBT Turn-off Switching Waveforms & definition of $t_{d\text{off}}$, $t_{E\text{off}}$ ($t_{E\text{off}}$ = integrating time for E_{off})



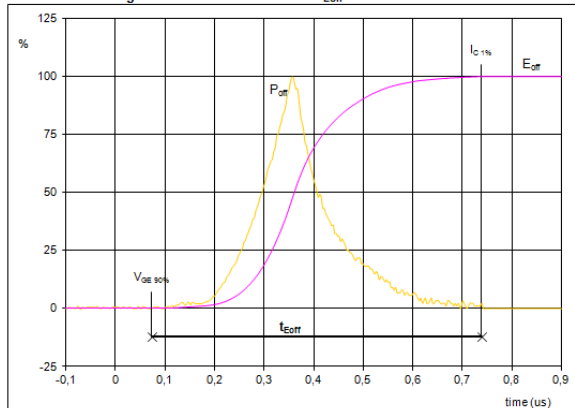
$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	15	A
$t_{d\text{off}} =$	0,26	μs
$t_{E\text{off}} =$	0,67	μs

Figure 3. IGBT Turn-off Switching Waveforms & definition of t_r



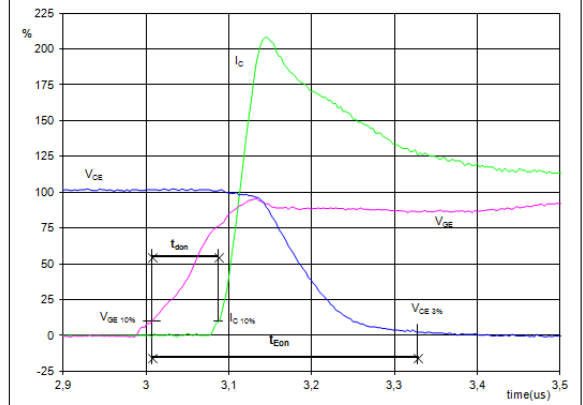
$V_C(100\%) =$	600	V
$I_C(100\%) =$	15	A
$t_r =$	0,13	μs

Figure 5. IGBT Turn-off Switching Waveforms & definition of $t_{E\text{off}}$



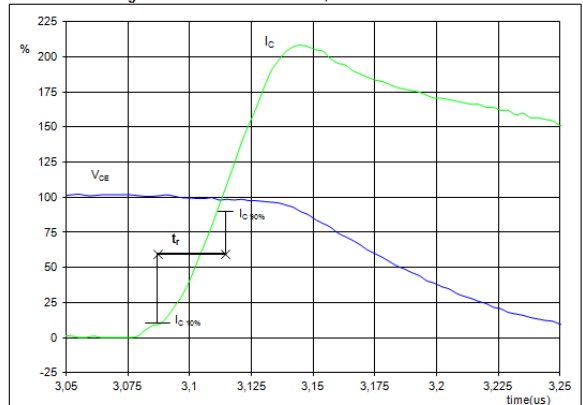
$P_{\text{off}}(100\%) =$	9,03	kW
$E_{\text{off}}(100\%) =$	1,37	mJ
$t_{E\text{off}} =$	0,67	μs

Figure 2. IGBT Turn-on Switching Waveforms & definition of $t_{d\text{on}}$, $t_{E\text{on}}$ ($t_{E\text{on}}$ = integrating time for E_{on})



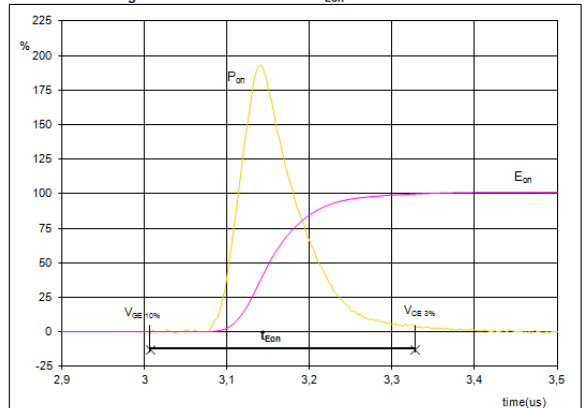
$V_{GE}(0\%) =$	-15	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	600	V
$I_C(100\%) =$	15	A
$t_{d\text{on}} =$	0,08	μs
$t_{E\text{on}} =$	0,32	μs

Figure 4. IGBT Turn-on Switching Waveforms & definition of t_r



$V_C(100\%) =$	600	V
$I_C(100\%) =$	15	A
$t_r =$	0,02	μs

Figure 6. IGBT Turn-on Switching Waveforms & definition of $t_{E\text{on}}$



$P_{\text{on}}(100\%) =$	9,03	kW
$E_{\text{on}}(100\%) =$	1,40	mJ
$t_{E\text{on}} =$	0,32	μs



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Switching Definitions

Figure 7. FWD

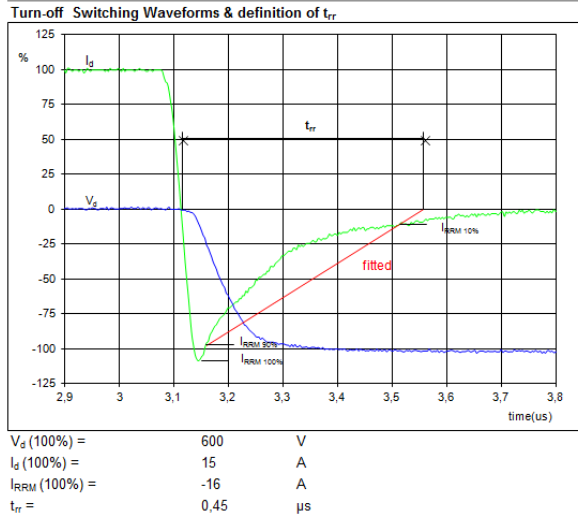


Figure 8. FWD

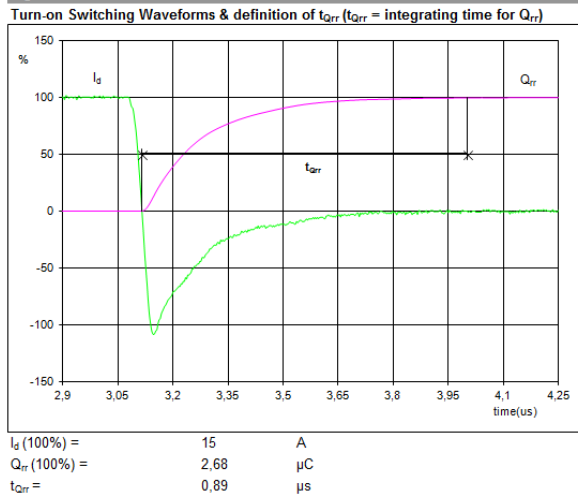
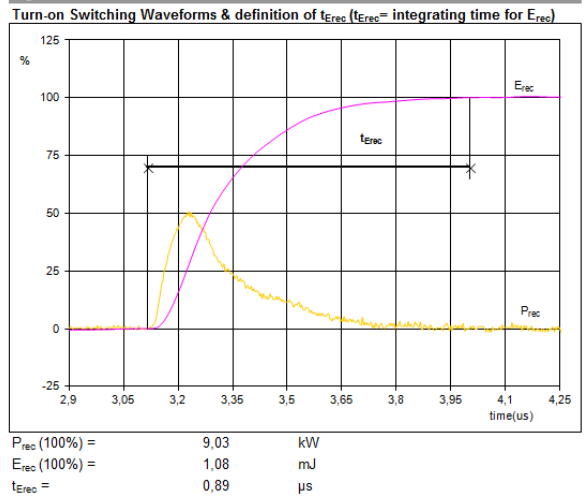


Figure 9. FWD

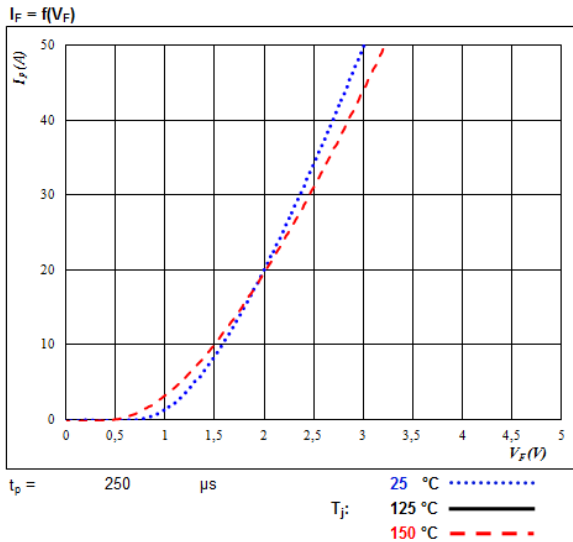




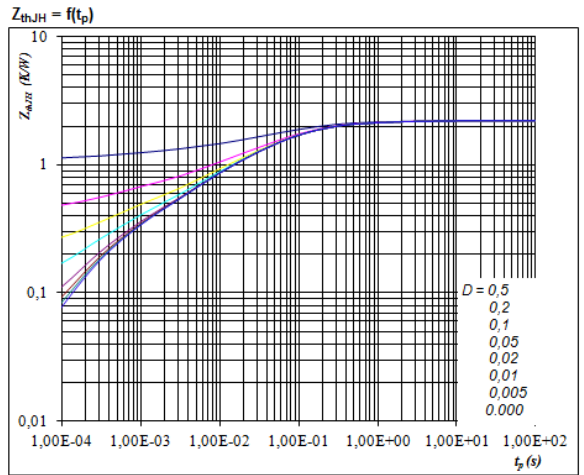
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Inverter diode characteristics

Typical forward characteristics FWD



Transient thermal impedance as a function of pulse width FWD



$D = t_p / T$
 $R_{thJH} = 2.2 \text{ K/W}$

FWD thermal model values

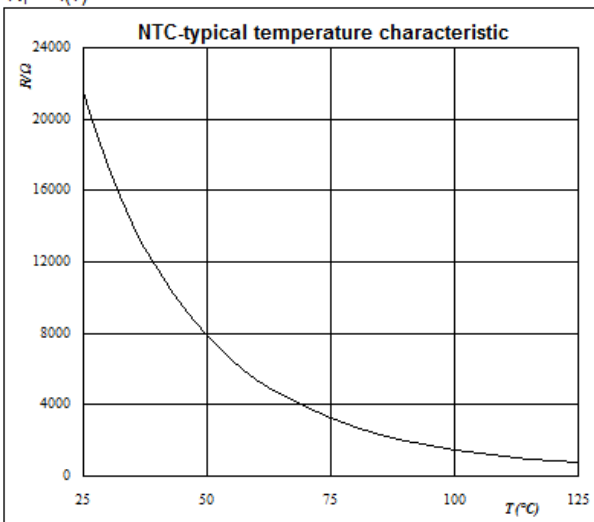
R (K/W)	Tau (s)
3,54E-02	8,43E+00
1,46E-01	9,82E-01
6,08E-01	1,40E-01
6,27E-01	3,75E-02
4,62E-01	7,22E-03
2,00E-01	8,47E-04

Thermistor

Figure 1 Thermistor


Typical NTC characteristic as a function of temperature

$R_T = f(T)$

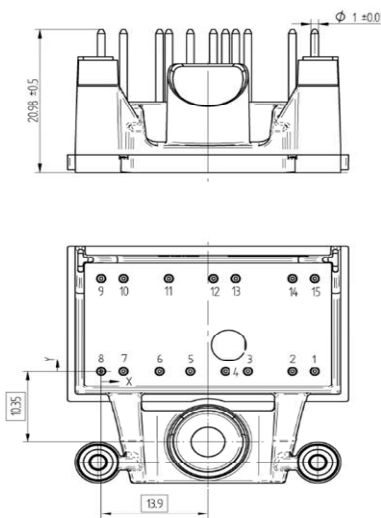




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Ordering Code & Marking							
Version			Ordering Code				
without thermal paste 17mm housing with solder pins			10-0B126PA015SC-M999F09				
		Text	Name	Type&Ver	Date code	VIN & Lot	Serial&UL
NN NNNNNNNNNNN NN TTTTITTVV VIN LLLL WWYY SSSSUL			NN-NNNNNNNNNNNNNN	TTTTTTTVV	WWYY	VIN LLLLL	SSSS UL
		Datamatrix	Type&Ver	Lot number	Serial	Date code	
			TTTTTTTVV	LLLLL	SSSS	WWYY	

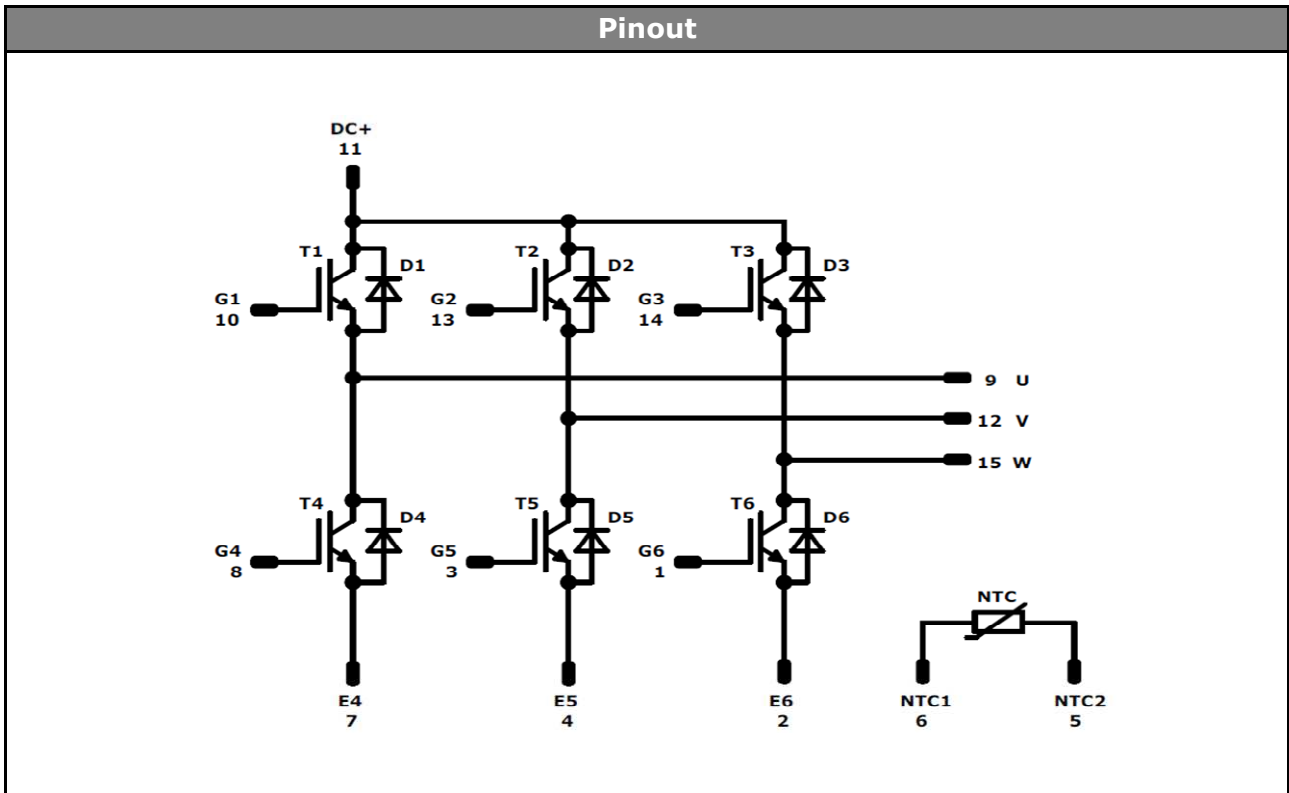
Pin table [mm]			
Pin	X	Y	Pos
1	27,8	0	G6
2	24,9	0	E6
3	19,1	0	G6
4	16,2	0	E5
5	11,6	0	NTC2
6	7,6	0	NTC1
7	2,9	0	E4
8	0	0	G4
9	0	13,7	U
10	2,9	13,7	G1
11	8,8	13,7	DC+
12	14,6	13,7	V
13	17,5	13,7	G2
14	24,9	13,7	G3
15	27,8	13,7	W



Tolerance of pinpositions: ±0.5mm at the end of pins
Dimension of coordinate axis is only offset without tolerance
PCB cutouts and holes see in handling instruction document



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Identification					
ID	Component	Voltage	Current	Function	Comment
T1-T6	IGBT	1200 V	15 A	Inverter switch	
D1-D6	FWD	1200 V	15 A	Inverter diode	
NTC	NTC			Thermistor	



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Packaging instruction					
Standard packaging quantity (SPQ)	160	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow0B</i> packages see vincotech.com website.

Document No.:	Date:	Modification:	Pages
10-0B126PA015SC-M999F09-T2-14	26 Jun 2017	Updated packaging quantity	14

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.